



<b>ENGINEERING DEPT.</b>		<b>PRODUCT SPECIFICATION</b> <b>For CI27 Connector System</b>	<b>SPEC.NO.: SPCI042B</b>
<b>REVISIONS</b>	<b>ECNT120150</b>		<b>PAGE: 1/3</b>

1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and procedure with terminals crimped on the specified maximum size wire

2. APPLICABLE STANDARDS:

MIL - STD - 202                      Methods for test of connectors for electronic equipment  
EIA - 364                                Test methods for electrical connectors

3. APPLICABLE SERIES NO.: CI27 Series

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 Thickness: 1.6 mm (.063")

6.2 P.C. Board Layout: See attached drawings

REVIEWED : Eisley APPROVED : Sun VERIFIED : Michelle .

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**7. ELECTRICAL PERFORMANCE:**

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage		3A 250V AC (r.m.s.)
7.2	Contact resistance	Dry circuit of DC 20 mV max. , 100 mA max.	Less than 20 mΩ
7.3	Dielectric strength	When applied AC 1000 V 1 minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than 1000 MΩ

**8. MECHANICAL PERFORMANCE:**

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Wire size	Specified wire size	Accepts AWG#22~#28
8.2	Terminal crimp Tensile strength	When crimped AWG#22 size wire When crimped AWG#24 size wire When crimped AWG#26 size wire When crimped AWG#28 size wire	More than 5.0 Kgf More than 3.0 Kgf More than 2.0 Kgf More than 1.3 Kgf
8.3	Terminal insertion force	Insertion speed 25± 3 mm per minute into housing	Less than 500 gram
8.4	Contact retaining force in insulator	Retention speed 25± 3 mm per minute from housing	More than 1.5 Kgf

**9. ENVIRONMENTAL PERFORMANCE:**

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	Then carried the rated current	30°C max.
9.2	Solderability	Soldering time: 5 ± 0.5 second Soldering pot: 230 ± 5°C	Minimum: 90% of immersed area
9.3	Resistance to soldering heat	Soldering time: 5 ± 0.5 second Soldering pot: 260 ± 5°C	No damage
9.4	Heat aging	85 ± 2°C , 96 hours	No damage
9.5	Humidity	40 ± 2°C , 90-95% RH , 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Dielectric strength: To pass para 7-3



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	ITEM	TEST CONDITION	REQUIREMENT
9.6	Temperature cycling	<p>One cycle consists of :</p> <p>(1) <math>-55 \begin{smallmatrix} +0 \\ -3 \end{smallmatrix} ^\circ\text{C}</math> , 30 min.</p> <p>(2) Room temp. 10-15 min.</p> <p>(3) <math>85 \begin{smallmatrix} +3 \\ -0 \end{smallmatrix} ^\circ\text{C}</math> , 30 min.</p> <p>(4) Room temp. 10-15 min.</p>	Appearance: No damage
9.7	Salt spray	<p>Temperature: <math>35 \pm 3^\circ\text{C}</math></p> <p>Solution: <math>5 \pm 1\%</math></p> <p>Spray time: <math>48 \pm 4</math> hours (Stamping before plated)</p> <p>Spray time: <math>24 \pm 4</math> hours (Stamping after plated)</p> <p>Mate connectors and expose to the following salt mist conditions. Upon completion of the exposure period, salt deposits shall be removed by a gentle wash or dip in running water and dried naturally, after which the specified measurements shall be performed.</p> <p>The specimens shall be suspended from the top using waxed twine, string or nylon thread.</p> <p>The test only define the plating area, without plating area (as copper cross section) will not be defined.</p> <p>(EIA 364-26B / MIL-STD-202 Method 101)</p>	<p>Appearance: No damage</p> <p>Contact resistance: Less than twice of initial</p>

10. AMBIENT TEMPERATURE RANGE: -25 to + 85 °C